As a below named inventor, I declare: that I verily believe myself to be the original, first and sole (if only one individual inventor is listed below) or an original, first and joint inventor (if more than one individual inventor is listed below) of the invention in

SEMICONDUCTOR DEVICE USING PARTIAL SOI SUBSTRATE AND MANUFACTURING METHOD THEREOF

the specification of which is attached hereto unless the following box is checked.

as United States Application □ was filed on or PCT International Application No. (if applicable). was amended on \_\_\_\_\_

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

referred to above. I acknowledge the duty to disclose information of which is material to patentability as defined in 37 CFR 1.56. I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365 (b) of any foreign application(s) for patent or inventor's certificate, or 35 U.S.C. 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certification inventor's certification inventor's certification in the low any foreign application for patent or inventor's certification inventor's certification for patent or inventor's certification for patent or inventor's certification for patent or inventor's certification. least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

Priority Claim Filing Date Category Application No. ff Country December 27, 2001 Yes 2001-398480 Ų Japan Patent 

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I hereby appoint the registrants of Oblon, Spivak, McClelland, Maier & Neustadt, P.C., Fourth Floor, 1755 Jefferson Davis Highway, Arlington, Virginia 22202, Customer No. 22850, or any one of them. Send correspondence to Oblon, Spivak, McClelland, Mailer & Neustadt, P. C., Fourth Floor, 1755 Jefferson Davis Highway, Arlington, Virginia 22202, Telephone No. (703) 413-3000.

I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

## DECLARATION FOR PATENT APPLICATION

I declare further that my mailing address is at c/o Intellectual Property Division, KABUSHIKI KAISHA TOSHIBA, 1-1 Shibaura 1-chome. Minato-ku, Tokyo 105-8001, Japan; and that my citizenship and residence are as stated below next to my name:

Inventor: (Signature)	Date	Residence
	Date: FEB 8. 2002	
Hajime Naganos	Citizen of: Japan	Yokohama-shi, Japan
Halime Nagano		
	<sub>Date:</sub> FEB. – 8. 2002	_
Shinichi Milto	Citizen of: Japan	Yokohama-shi, Japan
	FEB 8. 2002	_
Hisato Oyamatsu	Citizen of: Japan	Yokohama-shi, Japan
Hisato Oyamatsu		
History Oyama tsu  History 10  History 10	Date:	_
### ## ###	Citizen of: Japan	
5 (-1) 2-13 2-13		
## ## ## ## ## ## ## ## ## ## ## ## ##	Date:	_
<b>14 </b>	Citizen of: Japan	
there.		
	Date:	_
	Citizen of: Japan	
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	Date:	_
	Citizen of: Japan	